

Electronic Patent Application Fee Transmittal

Application Number:	10721225			
Filing Date:	26-Nov-2003			
Title of Invention:	Method and structures for increasing the structure density and the storage capacitance in a semiconductor wafer			
First Named Inventor/Applicant Name:	Joern Luetzen			
Filer:	James Kesterson/Shelley Butz			
Attorney Docket Number:	INF 2004 SP 00115			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1202	8	50	400
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				400